

PROCESS CHANGE NOTICE
 PRODUCT CHANGE NOTICE
**MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE
 THAT MAY AFFECT THE FOLLOWING CATEGORIES:**

<input type="checkbox"/> DESIGN	<input type="checkbox"/> WAFER FAB	<input checked="" type="checkbox"/> ASSEMBLY	<input type="checkbox"/> TEST	<input type="checkbox"/> ELEC/MECH SPECS
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AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: Current sole assembly location is Amkor, Korea (ATK) for QFN packages 8x8 and below.

CHANGE TO: Move to assembly to Amkor, Philippines (ATP) for QFN packages 8x8 and below.

JUSTIFICATION: ATK is closing their facilities and moving all the equipment to ATP. ATP will be using the same equipment and materials as ATK. ATK will close their doors by 12/01/2016.

There is no changes in the form, fit, or function of the devices.

Please see the attached reliability report, R27085

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.



Deborah Meeker / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Maxim Integrated Company Representative or Deborah Meeker, PCN Coordinator
 408-601-5618 / pcn.coordinator@maximintegrated.com

Punched QFN BOM Comparison (ATK vs ATP)

ASSEMBLY VENDOR	ATK (Current)	ATP (new)	Change
Assembly Location	ATK in Korea	ATP in Philippines	Yes
Package Type	Punched QFN	Punched QFN	NONE
Leadframe type	Copper	Copper	NONE
Die Attach type	Conductive	Conductive	NONE
Die Attach Brand	Ablestick 8290	Ablestick 8290	NONE
Mold Compound	Sumitomo G700	Sumitomo G700	NONE
Lead finish	Lead-free 100% matte tin	Lead-free 100% matte tin	NONE
Marking type	Laser	Laser	NONE